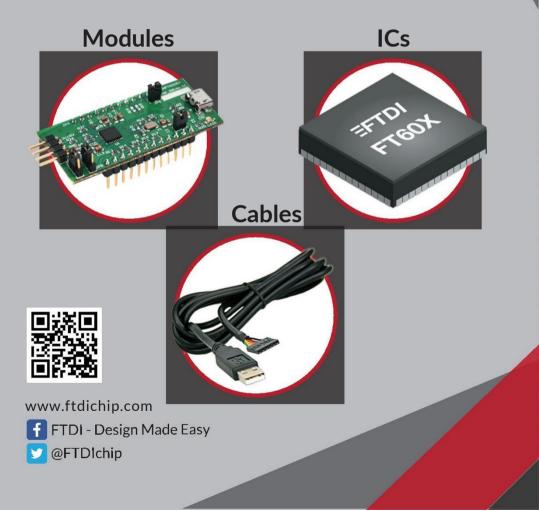


FTDI Chip USB Solutions

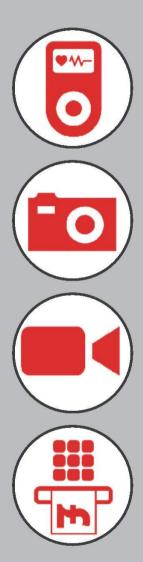
The USB Bridging Solution Specialist



USB AS EASY AS 123

FTDI Chip develops innovative silicon solutions that enhance interaction with today's technology. When a designer needs to add a USB port, rest assured that FTDI Chip has a full range of USB solutions to get the job done.

The Universal Serial Bus (USB) interface is now established as the de-facto interface for connecting systems with a reliable, low-cost digital link. USB has expanded beyond PC usage, and can now be found in all market segments, including Industrial, Medical, Consumer, Communications, Networking, and more. Enabling designers to implement USB quickly into a design, FTDI Chip provides total solutions including silicon chips, development tools, application notes, and software support. Expertise in USB bridges provides seamless integration for a variety of interfaces such as UART, FIFO, I2C, SPI, PWM and GPIO, where the bridge converts the signalling and protocol from the selected interface to USB. USB solutions are delivered in packages as small as 10 pin DFN (3x3mm); in modules that can be inserted into boards for development and production; or in cables that bridge USB to numerous interfaces. Whenever your development or product needs USB, check out FTDI Chip (www.ftdichip.com) for complete solutions that can shorten your design time, while providing robust system implementations.



Extensive USB Portfolio

Whether your design needs silicon chips, cables, or modules, check out FTDI Chip's large portfolio of USB and system level products.



Peripheral Or Host

USB connectivity designs are constructed from two distinct functional capabilities: a host and a device/peripheral type. As part of the total solution, FTDI Chip is able to offer both types of capabilities. With over 30 USB peripheral chips offered in 5 product families, designers can choose the device which best matches their system need. On the USB host side, the FT311D targets the Android ecosystem and joins the Vinculum family which provides system level capabilities with its micro-controller capability, USB host, and USB peripheral support.

Speed

FTDI Chip devices are aimed at full, high and super speed solutions. SuperSpeed USB 3.0 provides the greatest level of data throughput, while hi-speed and full speed devices continue to be a robust, growing market where matching system needs with device features can provide the optimum USB implementation.

Advanced Features

To conserve PCB area and offer additional system value, FTDI Chip adds unique features to enhance USB functionality, like battery charging detection which enables faster charging. FTDI Chip also offers devices linking one USB port to 1, 2, or



4 application interfaces without requiring a USB hub. Save space, power, and system cost when EEPROM (MTP) memory, or unique clocking features are utilized in your system design.

Software

Drivers for most major operating systems such as Windows, MAC OS, Android and Linux are available for free download thus allowing for easy integration with minimum development effort.



The Vinculum family of host controllers is also supported with free, precompiled firmware as well as a free toolchain for designers wishing to tailor the firmware to their specific requirements.

Modules



Development modules are available to enable rapid design development. The modules are available in a variety of mechanical formats to allow easy bread-boarding or immediate access to the bridge interfaces. Additionally application modules are available which provide specific system functionality.

Cables

Similar to the module solutions are a range of cables offering TTL, RS232, RS422 or RS485 level interfaces. These cables can be used for development purposes or as accessories for accessing existing products over USB.

USB 3.0 SUPER SPEED BRIDGE SOLUTION (FT600 SERIES)

The FT600 is the first release in a brand new SuperSpeed series from FTDI Chip. The device provides a USB3.0 SuperSpeed to FIFO bridge, which provides up to 5Gbps of bandwidth. With optional 16 and 32 bit FIFO interfaces, the FT600 enables connectivity for numerous applications including high resolution cameras and displays, multifunction printers and much more. The device supports Link Power Management (LPM) to enable greater power savings, and also supports Suspend and Remote Wakeup signaling. Moreover, the device provides Battery Charge Detection (BCD) and is supported on major operating systems including Windows, Linux and Mac.

This innovative new product is available in two space saving packages – 56QFN and 76QFN.

Part Number	Application Interface	Channels	Configurable IO Pins	Package	USB Class
FT600Q	16 bit FIFO	1/2/4	2	QFN56	D3xx
FT601Q	32 bit FIFO	1/2/4	2	QFN76	D3xx
FT602Q	32 bit FIFO	1/2/4	2	QFN76	UVC

Applications that need to transfer data over USB at faster rates benefit from the FT600:

- Multi Function Printers
- Scanners
- High resolution video cameras
- High resolution displays
- Professional still image cameras
- Data acquisition systems that require high bandwidth
- FPGA & MCU development boards that require high bandwidth connectivity



USB 2.0 HI-SPEED BRIDGE SOLUTION

H Chip Series

Fast, flexible, multi-channel USB bridges

Part Number	Application Interface	Channels	Clocking	EEPROM	Data Throughput	Package
FT232H	UART ASYNC FIFO SYNC FIFO MPSSE	1	External (12MHz)	External	12MBaud 8 Mbyte/s 40MByte/s 30Mbit/s	48 QFN 48 LQFP
FT2232H	UART ASYNC FIFO SYNC FIFO MPSSE x 2	2	External (12MHz)	External	12MBaud 8 Mbyte/s 40MByte/s 30Mbit/s	64 QFN 64 LQFP 56 VQFN
FT4232H	UART MPSSE x2	4	External (12MHz)	External	12MBaud 30Mbit/s	64 QFN 64 LQFP 56 VQFN
FT4232HA	UART MPSSE x2	4	External (12MHz)	External	12MBaud 30Mbit/s	64 QFN
FT4222H	SPI/I2C (Master/Slave) GPIO	4 Channel SPI slave selection	External (12MHz)	Internal OTP	Upto 27Mbps	32 VQFN

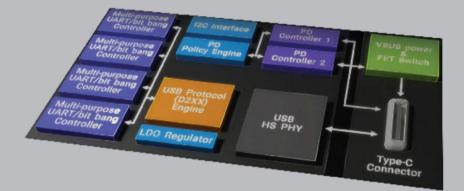
- IO Levels 3.3V (5V tolerant)
- Typical operating current 70mA
- Extended Temperature Range: -40°C to +85°C
- FT4232HA is Automotive grade Extended Temperature Range: -40°C to +105°C

In addition to the higher data rates these devices offer, (upto 40Mbytes/s) when compared to full speed solutions, the Hi-Speed series also offers a range of multichannel interfacing. The benefits of a multi channel bridge is that the system BOM is reduced by taking away the need for a USB hub chip. Additionally, each channel of the device appears to the host PC as a separate device enabling each channel to be independently configured for different modes, e.g. UART, MPSSE or FIFO and with different parameters such as 4 UARTS all operating with different baud rates.

For portable or battery operated devices the FT4222H also offers support for battery charger detection, enabling higher charge currents to be requested thus reducing battery charge times.

POWER DELIVERY SERIES

HI-SPEED USB BRIDGE with ENHANCED POWER DELIVERY



The Power Delivery series has up to two Type-C/PD ports, with PD1 port supporting both power sink and source roles (Initial Sink), and PD2 port only supporting a power sink port role.

Both PD ports support 5V, 9V, 12V, 15V and 20V PDO profiles, and these profiles are configurable through the external EEPROM at power-up or reset. PD1 port shares the same Type-C connector with USB data, and PD2 port is power port only without USB data.

Part Number	Application Interface	Channels	Power Delivery Ports	EEPROM	Data Throughput (Max)	Package
FT232HP	UART ASYNC FIFO SYNC FIFO MPSSE	1	1	External	12MBaud 8MByte/s 40MByte/s 30Mbit/s	56 QFN
FT233HP	UART ASYNC FIFO SYNC FIFO MPSSE	1	2	External	12MBaud 8MByte/s 40MByte/s 30Mbits	64 QFN
FT2232HP	UART ASYNC FIFO SYNC FIFO MPSSE x2	2	1	External	12MBaud 8MByte/s 40MByte/s 30Mbits	68 QFN
FT2233HP	UART ASYNC FIFO SYNC FIFO MPSSE x2	2	2	External	12MBaud 8MByte/s 40MByte/s 30Mbit/s	76 QFN
FT4232HP	UART MPSSE x2	4	1	External	12MBaud 30Mbit/s	68 QFN
FT4233HP	UART MPSSE x2	4	2	External	12MBaud 30Mbit/s	76 QFN

- IO Levels 3.3V (5V tolerant)
- Typical operating current 70mA
- Extended Temperature Range: -40°C to +85°C

In addition to the higher data rates these devices offer, (up to 40Mbytes/s) when compared to full speed solutions, the Hi-speed series also offers a range of multichannel interfacing. The benefit of a multi-channel bridge is that the system BOM is reduced by removing the need for a USB hub chip.

Additionally, each channel of the device appears to the host PC as a separate device enabling each channel to be independently configured for different modes, e.g. UART, MPSSE or FIFO and with different parameters such as 4 UARTS all operating with different baud rates.

X Chip Series

Optimised for small footprint, low power and battery charger detection.

Part Number	Application Interface	Channels	Configureable CBUS Pins	MTP Memory	Data Throughput	Package
FT200XD	I ² C	1	1	Internal	3.4Mbit/s	10 DFN
FT201XQ	I ² C	1	7	Internal	3.4Mbit/s	16 QFN
FT201XS						16 SSOP
FT220XQ	4-Bit SPI/	1	1	Internal	500kByte/s	16 QFN
FT220XS	FT1248					16 SSOP
FT221XQ	8-Bit SPI/	1	1	Internal	1MByte/s	20 QFN
FT221XS	FT1248					20 SSOP
FT230XQ	Basic UART	1	4	Internal	3MBaud	16 QFN
FT230XS					16 SSOP	
FT231XQ	Full	1	4	Internal	3MBaud	20 QFN
FT231XS	Handshake UART					20 SSOP
FT234XD	Basic UART	1	1	Internal	3MBaud	12 DFN
FT240XQ	8-bit FIFO	1	2	Internal	1MByte/s	24 QFN
FT240XS						24 SSOP

- IO Levels 1.8V to 3.3V (5V tolerant)
- Typical operating current 8mA
- Battery Charger Detection
- Internal data buffering: TX 512 bytes, RX 512 bytes
- Internally generated clocking No external crystal required. (when VCC >4.0V).
- Extended Temperature Range: -40°C to +85°C

The X-chip series for full speed USB bridge solutions is the latest generation in full speed USB bridging technology, offering the widest range of interface options all backed up with robust driver support on Windows, Linux, MAC OSX and WinCE.

R Chip Series

Optimised for minimal external components on a PCB design. It is not recommended for new design.

Part Number	Application Interface	Channels	Configureable CBUS Pins	EEPROM	Data Throughput	Package
FT232RL	UART	1	5	Internal	3MBaud	28 SSOP
FT232RQ						32 QFN
FT245RL	8-bit FIFO	1	0	Internal	1MByte/s	28 SSOP
FT245RQ						32 QFN

- IO Levels 1.8V to 5V
- Typical operating current 15mA
 Internal data buffering: TX 128 bytes, RX 256 bytes
- Internally generated clocking No external crystal required.
- Extended Temperature Range: -40°C to +85°C

The R chip solution offers a highly integrated solution combining USB protocol handling, internal clock control and EEPROM capabilities in one IC package.

RN Chip Series

Optimised for minimal external components on a PCB design.

Part Number	Application Interface	Channels	Configureable CBUS Pins	EEPROM	Data Throughput	Package
FT232RNL	UART	1	5	Internal	3MBaud	28 SSOP
FT232RNQ						32 QFN
FT245RNL	8-bit FIFO	1	0	Internal	1MByte/s	28 SSOP
FT245RNQ						32 QFN

To improve our supply efficiency on the popular R-Series, FTDI has launched the RN-Series which are designed / manufactured according to the R-Series specification.

The RN-series are drop in pin-compatible replacements for the equilavant R-Series in nearly 100% of all design cases.

The RN chip solution offers a highly integrated solution combining USB protocol handling, internal clock control and EEPROM capabilities in one IC package.

Any Migrating problem please refer to <u>AN_560</u>.

FT120T

Flexible, programmable bridges with in-built DMA engines.

Part Number	Application Interface	Endpoints Supported	Selectable Endpoints	Battery Charger Detection	Data Throughput	Package
FT120	Parallel (MCU)	6	Bulk Isochronous Interrupt	NO	Upto 1MByte/s	28 TSSOP

- IO Levels 3.3V to 5V
- Typical operating current 7mA
- Extended Temperature Range: -40°C to +85°C

While the other USB bridge devices focus on a fixed vendor USB class with silicon and host driver support both supplied and configured for maximum compatibility and efficiency the FT120T allows for something a little different.

The FT120T provides a fully configurable device controlled by an external MCU allowing the device to be identified as a variety of USB device classes such as BOMs, HID, CDC etc thus enabling generic pre-loaded system drivers to access the USB port.

Applications:

- Printers
- Industrial Control
- FPGA USB expansion ports

HID CLASS USB SOLUTIONS

USB devices are not all the same. The descriptors for a device categorise the devices into different classes.

Classes include mass storage (for memory devices), CDC (for communication devices e.g. wireless dongles), printer, audio and HID (Human Interface Devices such as a keyboard) classes. FTDI's traditional USB bridge devices use a special vendor class, as USB to Serial is not strictly covered by the standard classes. This is why FTDI also offer free dedicated drivers for their devices.

However as the Internet of Things evolves and more and more devices are connecting on a variety of different embedded systems a market is emerging which is more suited to a standard class of device such as HID. The key benefit to the end user is that it is more likely a standard class driver will exist for these many platforms as opposed to vendor class drivers.

Selecting HID as the standard bridge class FTDI has developed the FT260 Full speed HID class device enabling USB to bridge with I2C Master, UART or GPIO peripherals. This opens up access to many sensor applications critical in a smart connected world.

Part Number	Application Interfacce	Channels	Configurable IO Pins	Package
FT260Q	I2C, UART, GPIO	1/2	14	QFN28
FT260S	I2C, UART, GPIO	1/2	14	SSOP28

- Standard USB device class requires no custom drivers
- Configurable interface selection for UART, I2C or both
- Wide IO voltage supporting from 1.8V to 3.3V output and 1.8V to 5V input
- Battery Charger Detection supported
- Provide internal E-Fuse for some basic configuration and external EEPROM for future settings
- Internally generated clock NO external crystal required.



USB HOST SOLUTIONS

As mobility accelerates, the need for host support in tablets, handsets, and consumer equipment becomes critical to enable USB connections. FTDI Chip is expanding its USB host solutions with a focus on: Android Open Accessories Initiative, add-on USB host capability for USB2.0 Hi-Speed, and continued support for system level solutions that include USB technology (16 bit microcontroller, USB host, and USB device capabilities). Integrated circuits that provide USB host ports in a system solution are provided in the Vinculum family of devices. The Vinculum II (VNC2) provides ample hardware support including 16 bit microcontroller, USB host and device capabilities, embedded flash memory, and extensive interface options. In addition, the VNC2 has an extensive suite of application ROM design files, and a toolchain for developing application specific designs.

	VNC2	FT311D	FT312D
Description	Programmable USB 2.0 Host/Device Controller	ANDROID USB Host	ANDROID USB Host
USB Speed	Full (12Mbps) / Low speed (1.5Mbps)	Full-Speed (12Mbps)	Full-Speed (12Mbps)
USB Transfer Types	Bulk, Interrupt, Isochronous	Bulk	Bulk
No. of USB ports	2	1	1
No. of external channels	Flexible	1	1
Supported External Interfaces	ASYNC FIFO, SYNC FIFO, UART, 2 x SPI SLAVE, 1 x SPI MASTER, GPIO, PWM, DEBUG PORT	GPIO, PWM, UART, I ² C Master, SPI Master, SPI Slave	UART
Core	16/32-bit Harvard MCU Core		
Internal Memory	16kB RAM 256kB FLASH	-	512B-Rx, 256B-Tx
Data rates	Up to 6MBaud	Up to 1MBaud	Up to 1MBaud
Configuration Storage	Internal flash	-	-
Clocking	12MHz Crystal	12MHz Crystal	12MHz Crystal
Operating temp.	-40°C to +85°C	-40°C to +85°C	-40°C to +85°C
Core supply	1.8V	1.8V	1.8V
IO Supply	3.3V	3.3V	3.3V
Packages	32/48 LQFP and QFN	32 LQFP and QFN	32 LQFP and QFN

Android Host (FT311D)

The FT311D IC is designed to specifically host Android platforms that support Android Open



Accessories Mode (Android 3.1 onwards). This chip will enumerate and enable an Android platform to provide a bridge to a variety of platforms selectable from 3 GPIO lines. The interfaces include GPIO, UART, PWM, I2C Master, SPI Master and SPI slave. Packaged in 32 pin QFN or LQFP options the device offers a small, reliable bridge to allow Android devices such as mobile phones or tablets to communicate with peripheral hardware over USB. The device does not require any drivers to be loaded on the Android platform and draws no power from the Android USB port as the FT311D is the USB host.

To support the FT311D host chip, FTDI is offering a development kit and GPIO interface

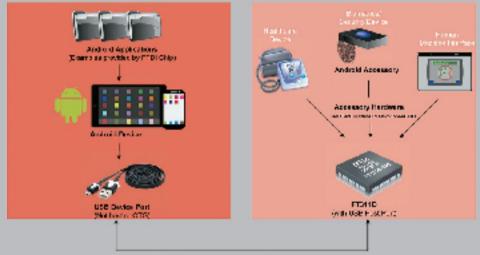
board to jump-start engineers' designs and provide easy access and integration into users' end systems.



With this fixed function, bridged host chip, designers can quickly and easily add USB functionality into products and connect to the expanding Android ecosystem.

USB2.0 Hi-Speed Host Solution FT312D

The FT312D is a USB 2.0 Full Speed host IC specifically targeted at providing access to peripheral hardware from an Android platform with a USB device port. The device will bridge the USB port to a UART interface via the Android Open Accessory protocol.

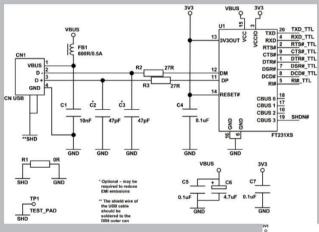


1985 Connection preschaget de connectivity (Solite elly, lite Audio o Accessory des vier des gel de Andreid device)

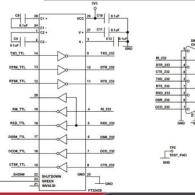
USB TO RS232 DESIGN

The simplest and most common use of FTDI devices is for the purpose of bridging USB ports to a UART peripheral interface. The UART interface may operate at 1.8V to 5V in which case it is possible to realize the design with only one IC such as the FT231X which will handle all the protocol translation on chip. If the design is connecting to either RS232, RS422, RS485 then the design will require an additional transceiver to convert the FT231X UART signals to the appropriate levels.

	TTL UART	RS232	RS422	RS485
Signal Swing	0V to 3V3/5V	+/-5V to +/- 15V	+/-2V	+/-1.5V
Termination	Single ended	Single Ended	Differential	Differential
Transmission length	~2m	~15m	~1200m	~1200m
No of transmitters/ receivers on a line	1 Driver 1 Receiver	1 Driver 1 Receiver	1 Driver 10 Receiver	32 Driver 32 Receiver



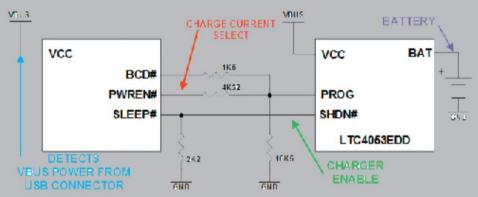
It is possible for the design to simply use RXD and TXD signals but with FTDI solutions the option to implement full modem control is also provided.



BATTERY CHARGER DETECTION

FTDI X Chips, FT4222H, FT260 and FT60X

Simplified charging circuit that support different mode for charging current adjustments.



VBUS	BCD#	PWREN#	*SLEEP#	CHG CURRENT
OV	LOGIC 0	LOGIC 0	LOGIC 0	0 – IN SHUTDOWN
5V Dedicated Charger	LOGIC 0	LOGIC 1	LOGIC 1	1.1A
5V Standard Downstream Port (Enumerated)	LOGIC 1	LOGIC 0	LOGIC 1	0.44A

Charge current is determined by the resistance to gnd on the prog pin of the LTC4053

More information in <u>Application Note 175</u>: Battery charger detection over usb with FT-X devices.

DEVICE DRIVER SUPPORT

Developing a USB solution is a two step process

- 1. The silicon required to translate the different protocols.
- 2. The drivers to communicate with the silicon.

FTDI offers among the most comprehensive range of OS supporting drivers on the market, thus facilitating one hardware solution to run on multiple platforms .

Drivers from FTDI can create virtual COM ports to allow legacy apps to control the USB device while talking to a UART interface or bus level drivers offering extended device control.

WINDOWS CERTIFIED	OTHERS
Windows 11 (64 bit)	Linux
Windows 10 (32/64bit)	MAC OSX
Windows 8.1 (32/64 bit)	Windows CE (Version 4.2 and greater)
Windows 8 (32/64 bit)	Windows RT
Windows 7 (32/64 bit)	Android*
Windows Server 2012 R2 x64	
Windows Server 2008 R2 x64	

*Android OS is supported though a JAVA interface, J2xx offering similar functionality to the bus level driver used on the other OS.

+Virtual COM Port drivers are shipped as part of the MAC OSX and Linux OS. As such this is often the simplest driver to use on these OS as to use the bus driver requires the VCP driver to first be disabled.

+Drivers for Windows must be installed by the user. However VCP and bus level drivers are supplied in a combined driver and can be installed together. 3 installation options are provided by FTDI.

- 1. WindowsupdatewillinstalldriversifthePCisconnectedtotheinternetandthedeviceispluggedin. This is perhaps the simplest for most users.
- 2. Windows provides a setup wizard that will start automatically if the device is plugged in and windows update is not used. This allows the most user control over the installation and setup.
- 3. A setup exe which automates the installation for non networked PCs. This 3rd option is a hybrid of options 1 and 2.

DEVICE DRIVER SUPPORT

D3XX Drivers

FTDI provides a new D3XX USB driver for FT600/FT601 SuperSpeed USB ICs. D3XX implements a proprietary protocol different from D2XX in order to maximize USB 3.0 bandwidth. Application software can access the USB device through a series of DLL function calls.

OPERATING SYSTEM	X86 (32-Bit)	X64 (64-Bit)	ARM	MIPS	APPLICATION LIBRARY
Windows*	1.3.0.4	1.3.0.4	-	-	1.3.0.4
Linux	1.0.0	1.0.0	ARM v6 (Hard Float) ARM v7 (Hard Float) ARM v8	-	
MAC OS X	0.5.21	0.5.21	-	-	
Android	0.5.21	0.5.21	-	-	

*Windows supported OS includes Win 7, 8, 8.1, 10

DEVELOPMENT MODULES

USB HOST SUPPORT



Description: FT311host development moduleconnectsto anAndroidUSBdeviceport. This development systemenablesthe bridgefromSPI master, SPI slave, I2C, UART, CPIO, andPWMtoa USBhost port. USBconnector: 1xType-A



Description: Arduinoinspired formfactorforVNC2 development. BasedonVNC2-64L andincludesadditional 10-bit ADC

USBconnector: TypeAandmini-B Notes:MaybeusedwithArduino orVNC2shields

VNC2Debugger/Programmer



Description: VNC2Programmer/ debuggermoduleforusewiththe IDEdevelopment tools USBconnector: Mini-B Notes:Usedtoloadanddebug firmwareinVNC2devices, viathe debugpin

V2DIP1-32



Description:

32pin/NC2-32Lbaseddevelopment moduleswithsingleUSBconnector. Themodulesaretargetedfor prototypingwiththeVNC2andfor applicationintegrationtoenableUSB capabilitywithinafinishedproduct design.

USBconnector: Onehost TypeA Notes: RequiresVNC2 programmingmodule

V2DIP2-48



Description: 48pinVNC2-48Lbased development moduleswithdual USBconnector. Themodulesare targetedforprototypingwith theVNC2andforapplication integrationtoenableUSB capability.withinafinished product design USBconnector: Twohost TypeA Notes: RequiresVNC2 programmingmodule



V2DIP2-32

Description: 32pinVNC2-32Lbased development moduleswithdual USBconnector. Themodulesare targetedforprototypingwith theVNC2andforapplication integrationtoenableUSB capabilitywithinafinished product design. USBconnector: Twohost TypeA Notes: RequiresVNC2 programmingmodule

V2DIP1-48



Description: 48pinVNC2-48Qbased

development moduleswithsingle USBconnector. Themodulesare targetedforprototypingwith theVNC2andforapplication integrationtoenableUSB capabilitywithinafinished product design. USBconnector: Onehost TypeA Notes: RequiresVNC2 programmigmodule

H-CHIP SERIES SUPPORT

USB2.0 Hi-Speed support with multi-channel capabilities

FT4232H Hi-SpeedSerial/Hub	UMFT4222EV	UMFT4222H PROG	FT2232H-56 Mini-Module	FT4232H-56 Mini-Module
Chip:FT4232HL USBconnector: TypeA FormFactor:36pin0.6" wideDIPwithoneUSB upstreamconnector andtwodownstream connectors Application: USBtoUART, MPSSEoraUSBhub. May act asanexpansiondevice toVNC2USBhost	Chip:FT4222H USBconnector.TypeA FormFactor: Standard 20.2mm(0.8") wide24pin DIPsocket: Pinsareona 2.60mm(0.1") pitch Application: USBtoSPI/ I2Cmaster/slave	Chip: FT4222H USBconnector: TypeA FormFactor: 42.38mmx 41.23mmboardmounted withcomponentsand connectors Application: For Programmingthe FT4222HICdescriptors	Chip: FT2232H-56Q USBconnector: MicroB FormFactor: Two26 pin doublerowheaders Application: USBtoUART, ASYNCFIFO, SYNCFIFO, or MPSSE x 2	Chip: FT4232H-56Q USBconnector: MicroB FormFactor: Two26pin doublerowheaders Application: USBtoUART, ASYNCFIFO, SYNCFIFO, or MPSSEx2

UM232H-B	UM232H	FT2232H MiniModule	FT4232H MiniModule
V			
Chip:FT232HL USBconnector: PCBtracksonly FormFactor: Breakout module Application: USBtoUART, ASYNC FIFO, SYNCFIFO, orMPSSE	Chip:FT232HL USBconnector: Mini-B FormFactor: 28pin0.6" wideDIP Application: USBtoUART, ASYNC FIFO, SYNCFIFO, orMPSSE	Chip: FT2232HL USBconnector: Mini-B FormFactor: Two26pindouble rowheaders Application: USBtoUART, ASYNC FIFO, SYNCFIFO, or MPSSEx 2	Chip:FT4232HL USBconnector: Mini-B FormFactor: Two26pindouble rowheaders Application: USBtoUARTor MPSSEx2

X-CHIP SERIES SUPPORT

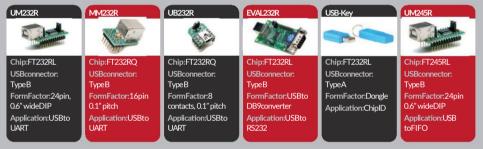
An advanced USB2.0 Full Speed Family with optimized power, footprint and feature set



* 'xxx' correlates to the numbers of the supported part types

R-CHIP SERIES SUPPORT

FTDI Chip's popular USB2.0 Full Speed Family



FT12 SERIES SUPPORT

Inspired by the D12, industry standard, with value-added features and footprints

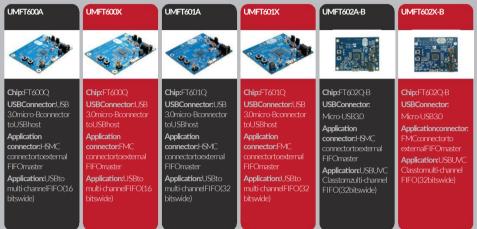
LOW COST DEVELOPMENT MODULES

UMFT12XEV	UMFT120DC	LC231X	LC234X
Description:Development system withLPC1114micro-controller forusewithdaughter-cardsfor systemdevelopment	Chip:FT120T USBConnector:Micro-B Footprint:28pin0.8" wideDIP	Chip:FT231XQ USBConnector:Micro-B FormFactor:One6pindouble rows7pinheader Application:USBtoUART	Chip:FT234XD USBConnector:Micro-B FormFactor:One6pinheader withoneright anglesocket and oneright anglepinheader Application:USBtoUART

DEVELOPMENT MODULES

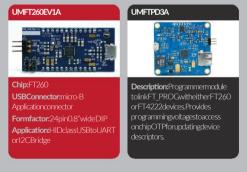
- FT60x-CHIP SERIES SUPPORT

An advanced USB3.0 Super Speed Family with multichannel support



FT260 HID Class Series Support

Full Speed HID Class devices ideal for USB sensors and no driver installation required



CABLE SOLUTIONS

USB TO LEGACY RS232 CONVERTER CABLES

		PARTNUMBER	IOLEVELS
		US232R-10	
	PremiumUSB to Legacy RS232 Converter	US232R-100	RS232
		US232R-500	
		UT232R-200	RS232
	USB-Serial Converter	UT232R-500	RS232
	Chipi-x	CHIPI-X10	RS232

USB TO LEGACY RS232 OR RS/ 22 OR RS485 CONVERTER CABLES

		PARTNUMBER	IOLEVELS
		USB-RS232-WE-1800-BT_0.0	
		USB-RS232-WE-1800-BT_3.3	
		USB-RS232-WE-1800-BT_5.0	00000
	RS232Converter ·	USB-RS232-WE-5000-BT_0.0	RS232
		USB-RS232-WE-5000-BT_3.3	
		USB-RS232-WE-5000-BT_5.0	
	RS422Converter	USB-RS422-WE-1800-BT	00400
		USB-RS422-WE-5000-BT	R\$422
	RS485Converter •	USB-RS485-WE-1800-BT	00405
		USB-RS485-WE-5000-BT	RS485

USB to I2C/SPI/JTAG



		PARTNUMBER	IOLEVELS
		TTL-232RG-VREG1V8-WE	1.8V
		TTL-232RG-VREG3V3-WE	3.3V
		TTL-232RG-VSW3V3-WE	3.3V
	~	TTL-232RG-VSW5V-WE	5V
	Type A USB to wire end TTL Serial	TTL-232RG-VIP-WE	1.8Vto5.25V
	Jeria	TTL-232R-3V3-WE	3.3V
		TTL-232R-5V-WE	5V
		TTL-234X-3V3-WE	3.3V
		TTL-234X-5V-WE	5V
	TypeAUSBtoSIPConnector	TTL-232R-5V	5V
$\langle \rangle$		TTL-232R-3V3	3.3V
		TTL-232R-3V3-2MM	3.3V
$\langle \rangle$		TTL-234X-3V3-2MM	3.3V
		TTL-234X-3V3	3.3V
		TTL-234X-5V	5V
1		TTL-232R-5V-AJ	5V
	Type A USB to 3.5mm Audio	TTL-232R-3V3-AJ	3.3V
	Jack	TTL-234X-3V3-AJ	3.3V
		TTL-234X-5V-AJ	5V
	Type A USB to 10 single pole	C232HD-EDHSP-0	5V
	receptacles	C232HD-DDHSP-0	3.3V

FTDI Chip's instant USB converter cables provide connectivity options from USB to RS232, RS422, or RS485 and TTL based signalling interfaces. The cables feature integrated electronics assemblies by using FTDI Chip's ICs, to provide an easy-to-use USB conversion. Custom cable versions are available upon request.

			CABLE	TEMPERATURE	
MAXBAUDRATE	RX/TXLED	CABLELENGTH	TERMINATION	RANGE	NOTES
		10cm			
1 Mbaud	RX/TXLED	1m	DB9	–20°C to +80°C	Retaining nut on DB9connector.
		5m			
1 Mbaud		2m	DB9	2000 - 10000	Thumb screw on DB9connector.
⊥ IMIDaUCI	-	5m	DBA	-20-0 10+80-0	I NUMB SCIEW ON DBACONNECTOR.
250kBaud	-	10cm	DB9	-40°C to +85°C	

POWEROUTPUT PIN	MAX BAUD RATE	RX/TXLED	CABLE LENGTH	CABLE TERMINATION	TEMPERATURE RANGE	NOTES
OV			1.8m			Option of transparent or black
3.3V			1.8m			USB connector.
5V	1 Mbaud		1.8m	Wire ended		LEDs for visual indication of traffic
OV		RX/TXLED	5m			on the cable.
3.3V			5m			
5V			5m			Also available as PCB.
OV	3 Mbaud	RX/TXLED	1.8m	\\ <i>fueeendeed</i>	Wire ended -40°C to +85°C	
00	3 I⊻ID∂UU	RAVIALED	5m	vvireended		
5V	2 Mbaud	RX/TXLED	1.8m	Wire ended	-40°C to +85°C	
	3 Mbaud		5m			

Poweroutput Pin	MAX BAUD RATE	RX/TXLED	CABLE LENGTH	CABLEEND	Temperature Range	NOTES
1.8V@100mA						
3.3V@250mA						LEDs for visual indication of traffic on the cable.
3.3V@50mA		RX/TXLED				u anicon u le cable.
5V@450mA	3 Mbaud		1.8m	Wire ended	-40°C to +85°C	
1.8Vto5.25V						Transparent USB connector.
5V@75mA						Available as PCB.
5V@75mA		-				Avaliable as PCD.
5V@75mA						0.1" pitch
5V@75mA	3 Mbaud		1.8m	Single in line socket	-40°C to +85°C	2mmpitch, for VMUSIC2 and
5V@75mA				JOENCL		VDRIVE2
-	3 Mbaud		1.8m	Audio Jack	-40°C to +85°C	Tip-Tx, Ring-Rx, Sleeve-Ground

1 adj.logic threshold level (from external supply)

* All cables are powered from the host USB port, except TTL-232RG-VIP-WE All cables use FTDI royalty free drivers - available on Windows, MAC, Linux, and WinCE All cables FCC/CE/UKCA approved • Custom cable options on request subject to MOQ/NRE



ABOUT FTDI CHIP

FTDI Chip develops innovative silicon solutions that enhance interaction with today's technology. The company prides itself on its existence as a USB bridging solution specialist, and applies this principle by supporting engineers with highly sophisticated, feature-rich, robust and simple-touse products. This enables creation of electronic designs with higher performance, fewer peripheral components, lower power budgets and diminished board real estate.

FTDI Chip's long-established, continuously expanding Universal Serial Bus (USB) product line

boasts such universally recognized product brands as the ubiquitous R-Chip, X-Chip, Vinculum, and H-Series.

FTDI Chip is a fab-less semiconductor company, partnered with the world's leading foundries. The company is headquartered in Glasgow, UK, with research and development facilities located in Glasgow, Singapore and Taipei (Taiwan), plus regional sales and technical support sites in Glasgow, Taipei, Tigard (Oregon, USA) and Shanghai (China).

www.youtube.com/FTDIChip www.facebook.com/FTDIDesignMadeEasy @FTDIChip

Regional Offices

Europe, Middle East, Africa	US	Asia/Pacific		
Future Technology Devices International Limited	Future Technology Devices International Limited (USA)	Future Technology Devices International Limited (Taiwan)	Future Technology Devices International Limited (China)	Future Technology Devices International Limited (Singapore)
Unit 1, 2SeawardPlace,	7130SWFirLoopTigard,	2F, No. 516, Sec. 1, NeiHu	Room1103, No. 666West	
Centurion Business Park, Glasgow, G411HH, United	OR97223-8160, USA	Road, Taipei 114, Taiwan	Huaihai Road, 200052, Shanghai, P.R. China	1 Tai Seng Avenue Tower A #03-06
Kingdom	Tel:	Tel:		Singapore 536464
	+1(503) 547-0988	+886-2-87971330	Tel: +86(21) 62351596	Tel: +65-68411174
Tel: +44(0) 1414292777 Fax: +44(0) 1414292758	Fax: +1(503) 547-0987	Fax +886-2-8751-9737	Fax: +86(21) 62351595	Fax +65-68416071
			E-Mail (Sales):	E-Mail (Sales):
E-Mail (Sales): sales1@ftdichip.com E-Mail (Support): support1@ftdichip.com	E-Mail (Sales): us.sales@ftdichip.com E-Mail (Support): us.support@ftdichip.com	E-Mail (Sales): tw.sales1@ftdichip.com E-Mail (Support): tw.support1@ftdichip.com	cnsales@ftdichip.com E-Mail (Support): cn.support@ftdichip.com	tw.sales1@ftdichip.com E-Mail (Support): tw.support1@ftdichip.com